Preferred Device

# **Silicon Switching Diode**

#### **Features**

• Pb-Free Package is Available

## ON Semiconductor®

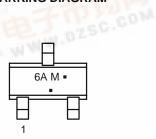
http://onsemi.com





SOT-416 / SC-75 **CASE 463** STYLE 2

## MARKING DIAGRAM



6A = Specific Device Code

= Date Code\* Μ

= Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or orientation may vary depending upon manufacturing location.

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
DA121TT1	SOT-416	3000 / Tape & Reel
DA121TT1G	SOT-416 (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

## **MAXIMUM RATINGS** $(T_A = 25^{\circ}C)$

Rating	Symbol	Max	Unit	
Continuous Reverse Voltage	V <sub>R</sub>	80	V	
Recurrent Peak Forward Current	IF	200	mA	
Peak Forward Surge Current Pulse Width = 10 μs	I <sub>FM(surge)</sub>	500	mA	

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation, FR-4 Board (Note 1) T <sub>A</sub> = 25°C	P <sub>D</sub>	225	mW
Derated above 25°C	M.075	1.8	mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	555	°C/W
Total Device Dissipation, FR-4 Board (Note 2) T <sub>A</sub> = 25°C	P <sub>D</sub>	360	mW
Derated above 25°C		2.9	mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	345	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

- 1. FR-4 @ Minimum Pad
- 2. FR-4 @ 1.0 × 1.0 Inch Pad



## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
Forward Voltage –	V <sub>F</sub>			mV
$(I_F = 1.0 \text{ mA})$		_	715	
$(I_F = 10 \text{ mA})$		_	866	
$(I_F = 50 \text{ mA})$		_	1000	
$(I_F = 150 \text{ mA})$		_	1250	
Reverse Current –	I <sub>R</sub>			μΑ
$(V_R = 75 \text{ V})$		_	1.0	
$(V_R = 75 \text{ V}, T_J = 150^{\circ}\text{C})$		_	50	
$(V_R = 25 \text{ V}, T_J = 150^{\circ}\text{C})$		-	30	
Capacitance – (V <sub>R</sub> = 0, f = 1.0 MHz)	C <sub>D</sub>	-	2.0	pF
Reverse Recovery Time – ( $I_F = I_R = 10$ mA, $R_L = 50 \Omega$ ) (Figure 1)	t <sub>rr</sub>	-	6.0	ns
Stored Charge – (I <sub>F</sub> = 10 mA to $V_R$ = 6.0 V, $R_L$ = 500 $\Omega$ ) (Figure 2)	QS	-	45	PC
Forward Recovery Voltage – ( $I_F = 10 \text{ mA}$ , $t_r = 20 \text{ ns}$ ) (Figure 3)	$V_{FR}$	_	1.75	V

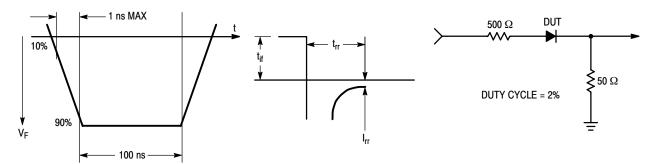


Figure 1. Reverse Recovery Time Equivalent Test Circuit

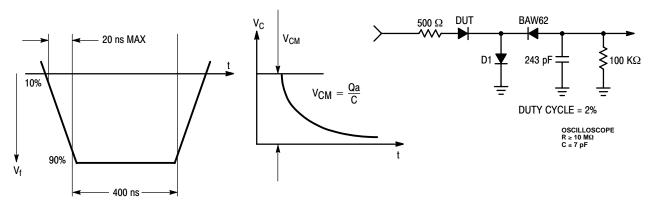


Figure 2. Recovery Charge Equivalent Test Circuit

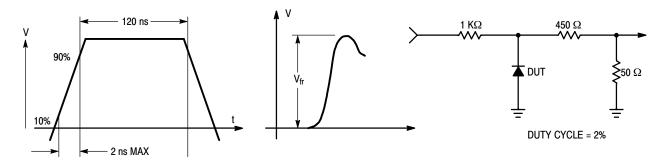
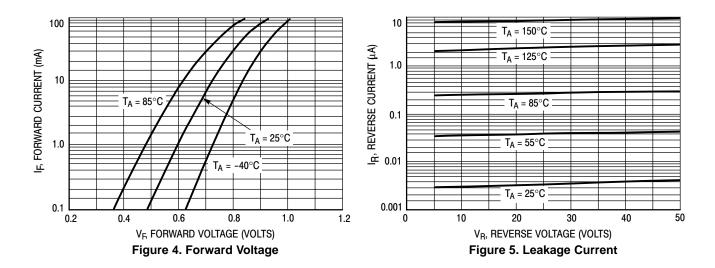
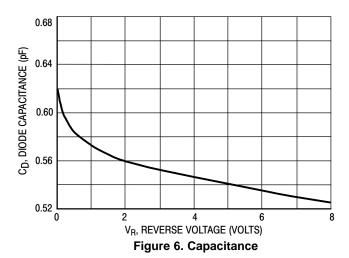


Figure 3. Forward Recovery Voltage Equivalent Test Circuit





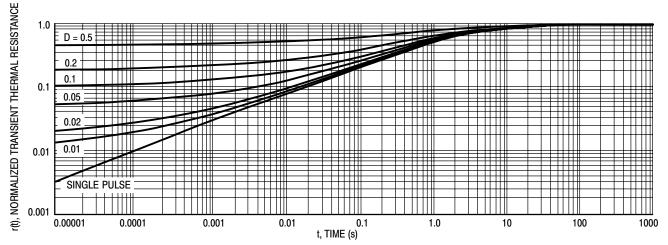
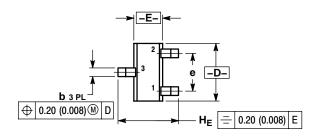


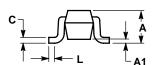
Figure 7. Normalized Thermal Response

http://oncomi.com

#### PACKAGE DIMENSIONS

SC-75 (SOT-416) CASE 463-01 ISSUE F





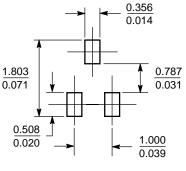
#### NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.

				INCUES.		
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.70	0.80	0.90	0.027	0.031	0.035
A1	0.00	0.05	0.10	0.000	0.002	0.004
р	0.15	0.20	0.30	0.006	0.008	0.012
С	0.10	0.15	0.25	0.004	0.006	0.010
D	1.55	1.60	1.65	0.059	0.063	0.067
E	0.70	0.80	0.90	0.027	0.031	0.035
е	1.00 BSC			0.04 BSC		
L	0.10	0.15	0.20	0.004	0.006	0.008
HL	1.50	1.60	1.70	0.061	0.063	0.065

STYLE 2: PIN 1. ANODE 2. N/C 3. CATHODE

#### **SOLDERING FOOTPRINT\***



SCALE 10:1  $\left(\frac{\text{mm}}{\text{inches}}\right)$ 

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and was a registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 61312, Phoenix, Arizona 85082–1312 USA Phone: 480–829–7710 or 800–344–3860 Toll Free USA/Canada Fax: 480–829–7709 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800–282–9855 Toll Free USA/Canada

Japan: ON Semiconductor, Japan Customer Focus Center 2–9–1 Kamimeguro, Meguro–ku, Tokyo, Japan 153–0051 **Phone**: 81–3–5773–3850

ON Semiconductor Website: http://onsemi.com

Order Literature: http://www.onsemi.com/litorder

For additional information, please contact your local Sales Representative.